

SGA30T120SFD

1200V 30A FieldStop Trench IGBT

Features

- FieldStop Trench Technology, Positive temperature coefficient
- $V_{CE(sat)}=2.5V@I_C=30A$
- $t_{rr}=48ns$ (typ.)
- High Speed Switching & Low Power Loss
- High Input Impedance

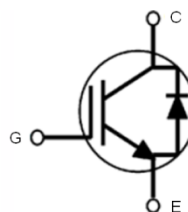
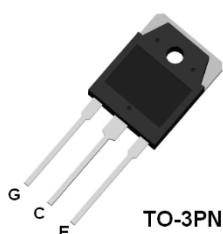
Applications

- PFC, UPS, Welder, PV Inverter

Description

The device is designed by advanced FieldStop Trench technology process. This IGBT offer low $V_{CE(sat)}$, high speed switching performance and excellent quality for application such as PFC,UPS, Welder, PV Inverter and other switching applications.

Package Type & Internal Circuit



Absolute Maximum Ratings

Symbol	Parameter		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		1200	V
V _{GES}	Gate to Emitter Voltage		±20	V
I _C	Collector Current	T _C =25℃	55	A
		T _C =100℃	30	A
I _{CM}	Pulsed Collector Current		100	A
I _F	Diode Continuous Forward Current	T _C =100℃	30	A
I _{FM}	Diode Maximum Forward Current		180	A
P _D	Maximum Power Dissipation	T _C =25℃	325	W
		T _C =100℃	175	W
T _J	Operating Junction Temperature Range		-40~+175	℃
T _{STG}	Storage Temperature Range		-50~+150	℃

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$ (IGBT)	Thermal Resistance, Junction to case for IGBT	0.5	$^{\circ}C/W$
$R_{th(J-C)}$ (Diode)	Thermal Resistance, Junction to case for Diode	1.7	$^{\circ}C/W$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	40	$^{\circ}C/W$

Electrical Characteristics of IGBT @T_C=25 °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} =0V, I _C =250μA	1200	-	-	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C =30A, V _{GE} =15V	-	2.5	2.8	V
		I _C =30A, V _{GE} =15V, T _C =150 °C	-	2.8	-	V
V _{GE(th)}	Gate Threshold Voltage	V _{CE} =V _{GE} , I _C =250μA	5.0	5.8	7.0	V
I _{CES}	Zero Gate Voltage Collector Current	V _{CE} =V _{CES} , V _{GE} =0V	-	-	1	μA
I _{GES}	Gate to Emitter Leakage Current	V _{GE} =V _{GES} , V _{CE} =0V	-	-	± 250	nA

Electrical Characteristics of Diode @T_C=25 °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V _F	Diode Forward Voltage	I _F =30A	-	3.8	4.2	V
		I _F =30A, T _C =150 °C	-	2.8	-	V
t _{rr}	Diode Reverse Recovery Time	I _F =30A, di/dt=-200A/us	-	48	-	ns
I _{rr}	Diode Peak Reverse Recovery Current		-	6.1	-	A
Q _{rr}	Diode Reverse Recovery Charge		-	1080	-	nC

Switching Characteristics @T_C=25 °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t _{d(on)}	Turn-on Delay Time	I _C =30A, V _{CC} =600V, V _{GE} =15V, R _G =10Ω, Inductive Load, T _C =25 °C	-	25	-	ns
t _r	Rising Time		-	20	-	ns
t _{d(off)}	Turn-off Delay Time		-	138	-	ns
t _f	Falling Time		-	44	-	ns
E _{on}	Turn-on Switching Loss		-	1.08	-	mJ
E _{off}	Turn-off Switching Loss		-	0.36	-	mJ
E _{ts}	Total Switching Loss	I _C =30A, V _{CC} =600V, V _{GE} =15V, R _G =10Ω, Inductive Load, T _C =150 °C	-	1.44	-	mJ
t _{d(on)}	Turn-on Delay Time		-	23	-	ns
t _r	Rising Time		-	22	-	ns
t _{d(off)}	Turn-off Delay Time		-	170	-	ns
t _f	Falling Time		-	110	-	ns
E _{on}	Turn-on Switching Loss		-	1.96	-	mJ
E _{off}	Turn-off Switching Loss	V _{GE} =0V, V _{CE} =25V, f=1.0MHz	-	0.62	-	mJ
E _{ts}	Total Switching Loss		-	2.58	-	mJ
C _{ies}	Input Capacitance	I _C =30A, V _{CC} =960V V _{GE} =15V	-	3942	-	pF
C _{res}	Reverse Transfer Capacitance		-	72	-	pF
C _{oes}	Output Capacitance		-	72	-	pF
Q _g	Total Gate Charge	V _{CC} =600V, V _{GE} =15V	-	204	-	nC
Q _{ge}	Gate to Emitter Charge		-	34	-	nC
Q _{gc}	Gate to Collector Charge		-	94	-	nC
tsc	Short Circuit With stand Time	V _{CC} =600V, V _{GE} =15V	8	-	-	us

Typical Performance Characteristics

Fig. 1. Typical Output Characteristics

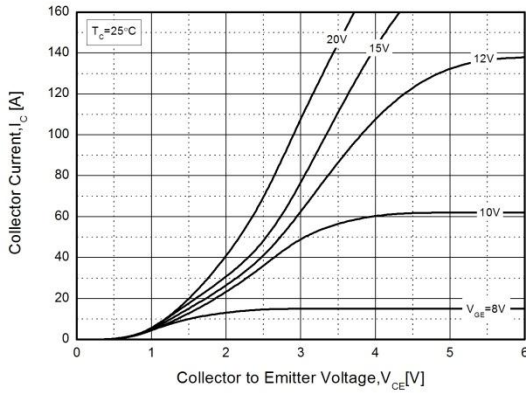


Fig. 2. Typical Saturation Voltage Characteristics

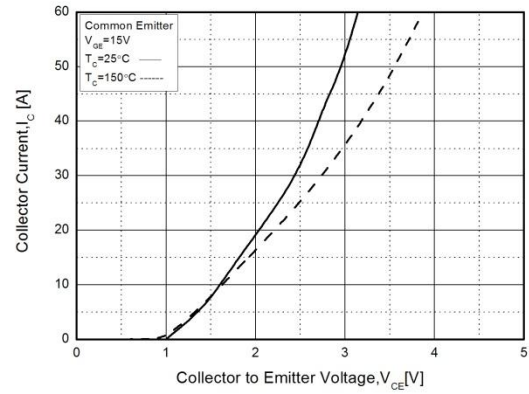
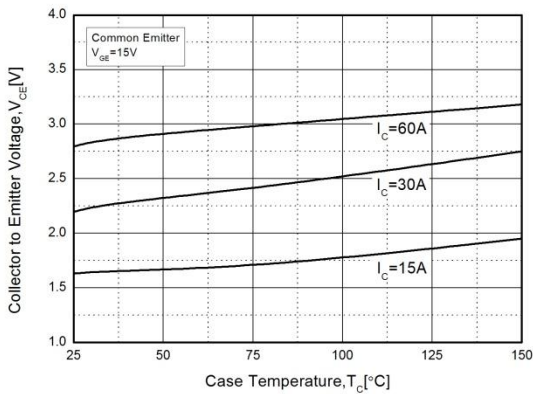

Fig. 3. Typical Saturation Voltage vs. T_C


Fig. 4. Diode Forward Characteristics

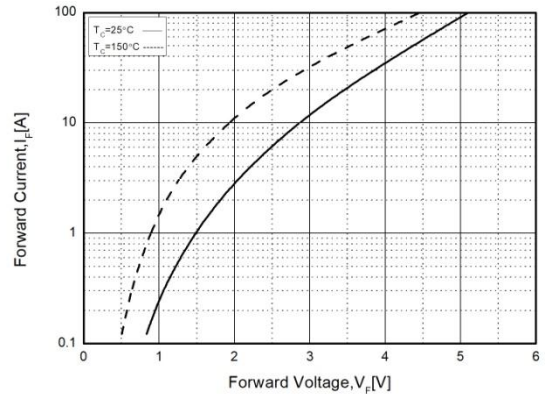
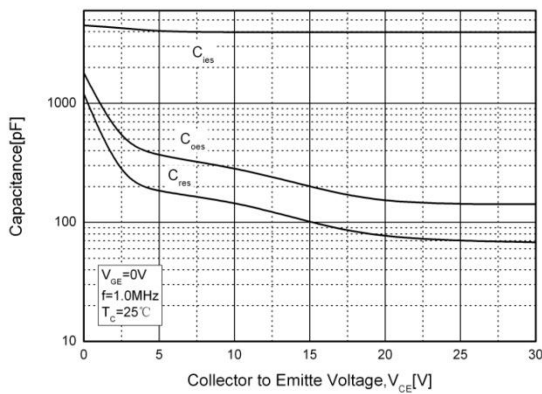
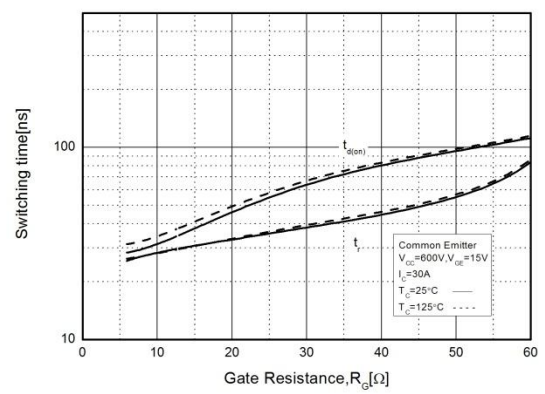
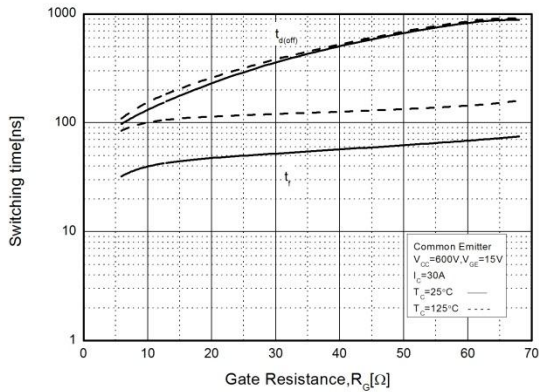
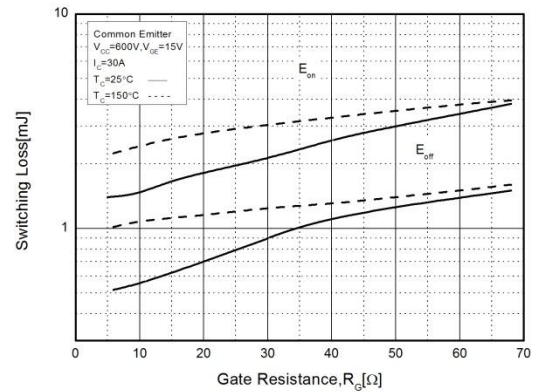
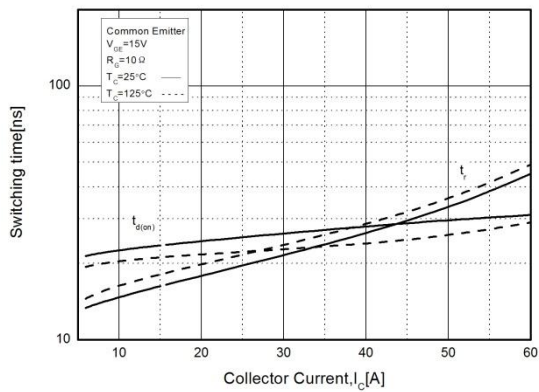
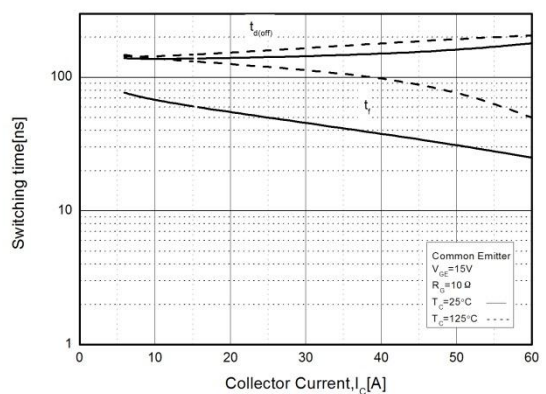
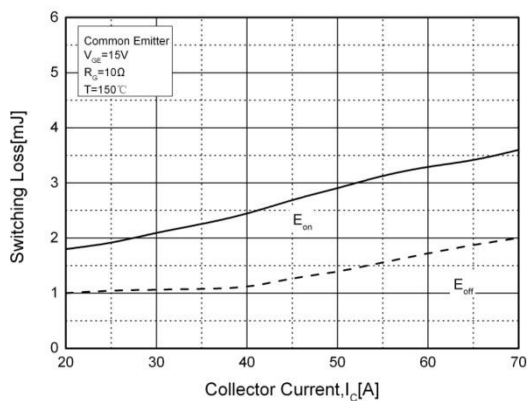


Fig. 5. Typical Capacitance Characteristics


Fig. 6. Turn-on Characteristics vs. R_G


Typical Performance Characteristics

Fig. 7. Turn-off Characteristics vs. R_G

Fig. 8. Switching Loss vs. R_G

Fig. 9. Turn-on Characteristics vs. I_C

Fig. 10. Turn-off Characteristics vs. I_C

Fig. 11. Switching Loss vs. I_C


Package Dimensions

TO-3PN

(Dimensions in Millimeters)

